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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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# DATA SHEET



# MOS FIELD EFFECT TRANSISTOR $\mu$ PA1763

## SWITCHING DUAL N-CHANNEL POWER MOS FET INDUSTRIAL USE

## DESCRIPTION

The  $\mu$ PA1763 is N-Channel MOS Field Effect Transistor designed for DC/DC Converters.

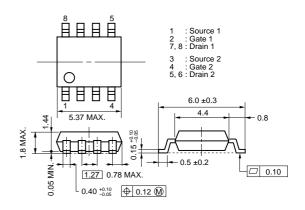
#### FEATURES

- Dual chip type
- Low on-resistance
- $\begin{array}{l} {\sf R}_{\sf DS(on)1} = 47.0 \mbox{ m}\Omega \mbox{ MAX. (VGs} = 10 \mbox{ V, Id} = 2.3 \mbox{ A}) \\ {\sf R}_{\sf DS(on)2} = 57.0 \mbox{ m}\Omega \mbox{ MAX. (VGs} = 4.5 \mbox{ V, Id} = 2.3 \mbox{ A}) \\ {\sf R}_{\sf DS(on)3} = 66.0 \mbox{ m}\Omega \mbox{ MAX. (VGs} = 4.0 \mbox{ V, Id} = 2.3 \mbox{ A}) \end{array}$
- Low input capacitance C<sub>iss</sub> = 870 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE
μPA1763G	Power SOP8

## PACKAGE DRAWING (Unit : mm)



#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, All terminals are connected.)

Drain to Source Voltage	VDSS	60	V	
Gate to Source Voltage	Vgss	±20	V	EQUIVALENT CIRCUIT
Drain Current (DC)	D(DC)	±4.5	А	
Drain Current (pulse) <sup>Note1</sup>	D(pulse)	±18	А	(1/2 Circuit)
Total Power Dissipation (1 unit) Note2	Рт	1.7	W	Drain
Total Power Dissipation (2 unit) Note2	Рт	2.0	W	
Single Avalanche Current Note3	las	4.5	А	Body
Single Avalanche Energy <sup>Note3</sup>	Eas	60	mJ	Gate F Diode
Channel Temperature	Tch	150	°C	
Storage Temperature	Tstg	–55 to + 150	°C	Gate J Protection Source Diode

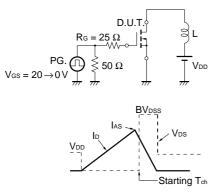
#### **Notes 1.** PW $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1 %

- **2.**  $T_A = 25 \text{ °C}$ , Mounted on ceramic substrate of 1200 mm<sup>2</sup> x 2.2 mm
- 3. Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0 V
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage Exceeding the rated voltage may be applied to this device.

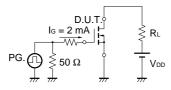
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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 2.3 A		37.0	47.0	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 2.3 A		45.0	57.0	mΩ
	RDS(on)3	Vgs = 4.0 V, Id = 2.3 A		49.0	66.0	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	Vds = 10 V, Id = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	VDS = 10 V, ID = 2.3 A	3.0	6.0		S
Drain Leakage Current	IDSS	Vds = 60 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 16 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		870		pF
Output Capacitance	Coss	Vgs = 0 V		150		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		80		pF
Turn-on Delay Time	td(on)	ID = 2.3 A		11		ns
Rise Time	tr	$V_{GS(on)} = 10 V$		40		ns
Turn-off Delay Time	td(off)	Vdd = 30 V		50		ns
Fall Time	tr	Rg = 10 Ω		12		ns
Total Gate Charge	QG	ID = 4.5 A		20		nC
Gate to Source Charge	QGS	Vdd = 48 V		3		nC
Gate to Drain Charge	Qgd	Vgs = 10 V		5		nC
Body Diode Forward Voltage	VF(S-D)	IF = 4.5 A, VGS = 0 V		0.80		V
Reverse Recovery Time	trr	IF = 4.5 A, VGS = 0 V		30		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		40		nC

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

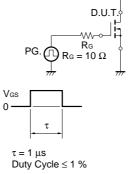


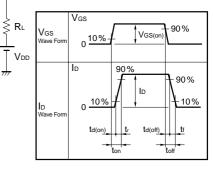
#### **TEST CIRCUIT 3 GATE CHARGE**



## TEST CIRCUIT 2 SWITCHING TIME

Т





100

10

1

0.1

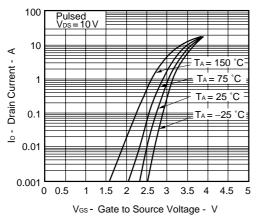
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|yis| - Forward Transfer Admittance

#### TYPICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

#### FORWARD TRANSFER CHARACTERISTICS



7.... T<sub>A</sub> = 75 °C

ID - Drain Current - A

10

25 °C

Τa 

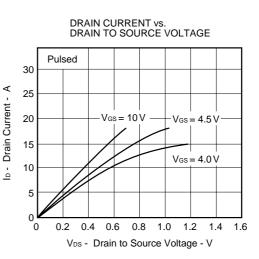
T<sub>A</sub> = 150 °C

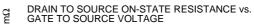
T<sub>A</sub> = 25 °C Ħ

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1

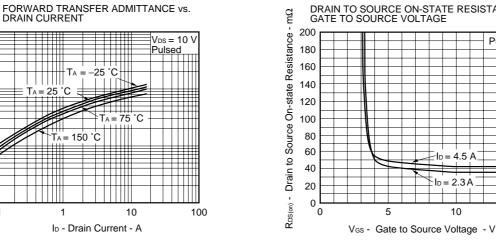
Pulsed

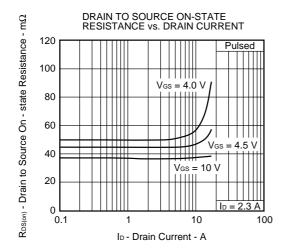




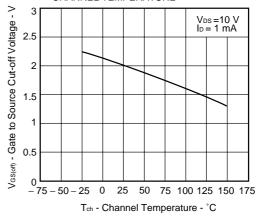
Pulsed

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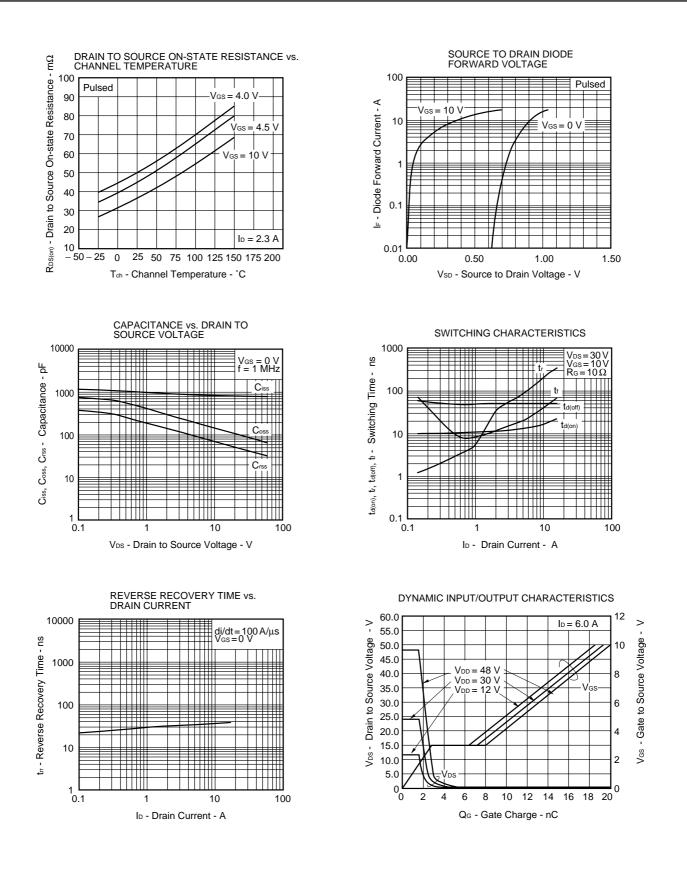


GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

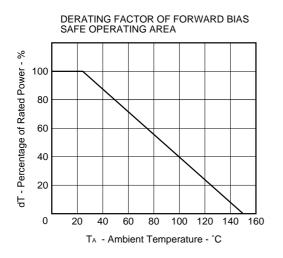


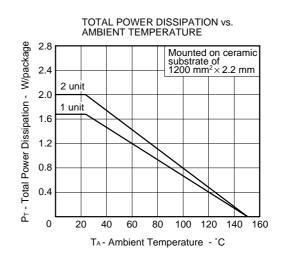
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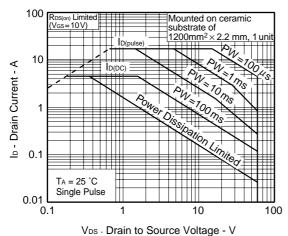


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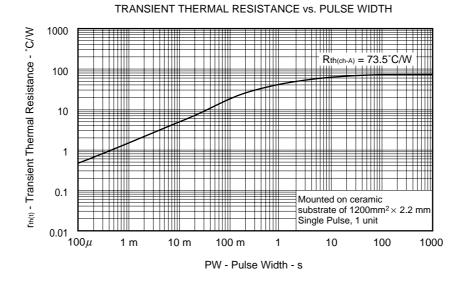


FORWARD BIAS SAFE OPERATING AREA

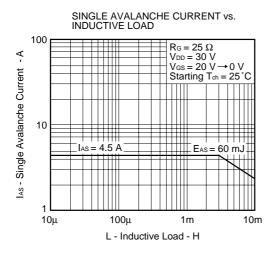


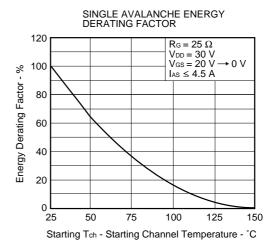
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